

# 5G NR/ 4G/ LTE Ceramic Chip Antenna

# ACR4006X

### Request Samples 🕥

Check Inventory

40 x 6 x 5 mm RoHS/RoHS II Compliant MSL Level = 3

## **Electrical Specification**

Parameter		Specification				
Operating Frequency		600 ~ 960, 1710 ~ 2690, 3300 ~ 6000 MHz				
Polarization		Linear				
Impedance		50 Ω				
Devile	5G NR	<b>n</b> - 1,2,3,5,6,7,12,14,18,20,25,28,29,30,34,38,39,40,41,48,65,66,70,71,77,78, 79,80,81,82,83,84,86,89,90,95				
Bands Supported	4G LTE	<b>B</b> - 1,2,3,4,5,7,8,12,13,14,17,18,19,20,25,26,28,29,34,37,38,39,41,42,43,44, 48,49,52,65,66,67,68,69,70,71,85				
	3G	PCS,DCA,UMTS				

Performance Characteristics												
Frequency (MHz)	617	698	700	824	960	1800	1900	2100	2600	3500	4500	5500
Efficiency (%)	31.37	51.86	60.03	54.16	65.11	76.02	74.75	77.43	30.07	41.13	61.78	45.83
Average Gain (dBi)	-5.03	-2.85	-2.21	-2.66	-1.86	-1.19	-1.26	-1.11	-5.21	-3.85	-2.09	-3.38
Peak Gain (dBi)	-2.33	0.87	1.26	0.14	0.95	3.56	3.54	4.42	-1.15	0.86	3.59	2.17

<u>Note</u> : All test measurements were conducted on 120 x 45 mm. Performance of the chip antenna will vary relative to the ground plane size in use.

### **Mechanical Specification**

Parameter	Specification	Unit
Antenna Dimension	40 x 6 x 5	mm
Antenna Clearance Space	45 x 13	mm
Evaluation Board size	120 x 45	mm
Solder Termination	Ag (Environmental-Friendly Pb-Free)	

#### **Environmental Specification**

Parameter	Specification
Operating Temperature	-40°C to 85°C
Storage Temperature	-40 C to 85 C
Relative Humidity	90% to 95%



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## **Test Measurement – Return Loss**



#### Test Measurement - VSWR





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# 5G NR/ 4G/ LTE Ceramic Chip Antenna **ACR4006X** Check Inventory Request Samples 🕥 40 x 6 x 5 mm **RoHS/RoHS II Compliant** MSL Level = 3 **Radiation Pattern** ABRACON Z **2D** Pattern XY Plane 0 30 330 617 MHz 700 MHz 824 MHz 960 MHz 60 1805 MHz 300 1910 MHz 2110 MHz 2595 MHz Power (dBm) 4500 MHz 500 MH 270 90 240 120 150 210 180 Angle (? 5101 Hidden Creek Ln Spicewood TX 78669 **ABRACON** ABRACON IS Phone: 512-371-6159 | Fax: 512-351-8858 **REVISED: 10-01-20** ISO9001-2015 For terms and conditions of sales, please visit: CERTIFIED www.abracon.com





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## **Reliability Tests**

Test	Test Condition				
Sinusoidal Vibration Test	The device is subject to 5 to 200 to 5Hz swept in 10 minutes, 4.5G at maximum (2mm amplitude), in X and Y directions for two hours each and in Z direction for four hours. After this test, examine its appearance functions.				
Vibration Test in Package Condition	The device is subject to vibrations of 15 to 60 to 15 Hz swept in 6 minutes, 4G at maximum (2mm amplitude at maximum), applied in X, Y and Z directions for two hours each, i.e. six hours in total. After this test, examine its appearance functions.				
Free Fall Test in packaged condition	Drop the object, which is packaged to a concrete surface from the height of 90 cm, on one comer, three edges and six faces once each, i.e. 10 times in total. After this test, examine its appearance functions.				
Solder Heat Resistance Test	The lead pins of the unit are soaked in solder bath at $270\pm5^{\circ}$ C for $10\pm0.5$ seconds and then be left for more than 1 hour at $25\pm5^{\circ}$ C in less than 65% relative humidity.				
Adhesion Test	The device is subjected to be soldered on test PCB. Then apply $0.5$ Kg (5N) of force for $10\pm1$ second in the direction of parallel to the substrate. (The soldering should be done by reflow and be conducted with care so that the soldering is uniform and free of defect by stress such as heat shock).				
Low Temperature Endurance	The device is exposed to the temperature -40°C for 16 hours and then normal temperature/humidity for 24 additional hours. After this test, examine its appearance functions.				
High Temperature Endurance	The device is exposed to temperature +85°C for 16 hours and then normal temperature/humidity for 24 hours or more. After this test, examine its appearance functions.				
High-Temperature/ High-Humidity Test	The device is exposed to the temperature +85°C and 90-95% relative humidity for 96 hours, and then expose it to normal temperature/humidity for 24 additional hours. After this test, examine its appearance functions.				
Thermal Shock Test	The device is exposed to a cyclic temperature change (-30°C, 30 minutes $\sim$ +85°C,30 minutes) for 5 cycles, then exposed to normal temperature/humidity for 24 additional hours. After this test, examine its appearance functions.				



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**Soldering Condition:** Soldering iron temperature 270±10 °C. Apply preheating at 120°C for 2-3 minutes. Finish soldering each terminal within 3 seconds, if the soldering iron is over 270±10 °C or 3 seconds, the component surface will peel or damage.

Phase	Profile features	Pb-Free Assembly (SnAgCu)		
PREHEAT	-Temperature Min(Tsmin) -Temperature Max(Tsmax) -Time(ts) form (Tsmin to Tsmax)	150℃ 200℃ 60-120 seconds		
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3℃/second(max)		
REFLOW	-Temperature(TL) -Total Time above TL (t L)	217℃ 30-100 seconds		
PEAK	-Temperature(TP) -Time(tp)	260℃ 20-30 second		
RAMP-DOWN	Rate	6℃ / second max.		
Time from 25℃	to Peak Temperature	8 minutes max.		
Composition of	solder paste	96.5Sn/3Ag/0.5Cu		
Solder Paste Mo	odel	SHENMAO PF606-P26		



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